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Product Specifications AN17850A

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Structure	Silicon Monolithic Bipolar IC
Appearance	SIL-12 Pins Plastic Package (FP-12S Power Type With Fin)
Application	Audio
Function	70W (6Ω) x 1ch BTL Power Amplifier Built-in Standby and Muting Features Incorporating Various Protection Circuits

A	Absolute Maximum Ratings				
No.	Item	Symbol	Ratings	Unit	Note
1	Storage Temperature	Tstg	-55 ~ +150	° C	
2	Operating Ambient Temperature	Topr	-25 ~ +75	° C	
3	Operating Ambient Pressure	Popr	$1.013x10^5 \pm 0.61x10^5$	Pa	
4	Operating Constant Acceleration	Gopr	9,810	m / s ²	
5	Operating Shock	Sopr	4,900	m / s ²	
6	Power Supply Voltage	Vcc	33	V	1
7	Power Supply Current	Icc	8.0	A	
8	Power Dissipation	PD	37.5	W	2

Operating Supply Voltage Range	Vcc	10 V ~ 32V
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Note: 1) Without input signal, Vcc is up to 33V 2) Ta = 75°C with infinite heatsink

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В	Electrical Characte		otherwise specified, the V, frequency=1kHz an				25° C±2° C,		
No			Test Condition			Limit			
No.	Item	Symbol	Ciṛ- cuit.	Condition	Min	Тур	Max	Unit	Note
1	Quiescent Circuit Current	Icq	1	No input; Vstby = 5V Vmute = 5V;	-	100	300	mA	
2	Output Noise Voltage	Vno	1	No Input, $Rg=20k\Omega$ Vstby = 5V;Vmute = 5V	-	0.54	1	mVrms	1
3	Voltage Gain	Gvc	1	Vin=20mV; Vstdby=5V Vmute = 5V	38	40	42	dB	
4	Total Harmonic Distortion	THD	1	Vin=20mV; Vstdby=5V Vmute = 5V;	-	0.07	0.4	%	2
5	Maximum Output Power	Po	1	THD_OUT=10% Vstdby=5V;Vmute= 5V;	55	70	-	W	
6	Output Offset Voltage	Voff	1	Rg=20kΩ; No input Vstdby=5V;Vmute=5V;	-350	0	350	mV	
7	Ripple Rejection	RR	1	Vripple=1Vrms * freq=120Hz, Rg=20kΩ	45	55	-	dB	1
8	Standby Current	I _{STB}	1	No input; vstdby=0V; Vmute=5V;	-	1	100	μА	
9	Muting Effects	MT	1	Vin=20mV; Vstby=5V; Vmute = 0 to 5V**	65	75	-	dB	2

Note: 1) With a filter band 20Hz ~20kHz (12 dB/OCT) used.

2) With a filter band 400Hz ~30kHz used.

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^{*} The measurement is by taking the ratio of output voltage with reference to the Vripple. ** The measurement is by taking the ratio of output (at Vmute = 0 V) to the output(at Vmute = 5 V)

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В	Electrical Characteristics (Unless otherwise specified, the ambient temperature is 25°C±2°C, Vcc=30V, frequency=1kHz and RL=6Ω.)						C,		
No	Item	Symbol	Test Cir-	Conditions		Limits			Note
	J. Titelli		cuit	Conditions	min	typ	max	Unit	
1	Standby on voltage	Vstdon	1	Vmute = 5V; Vin = 20mV; Istb < 100uA	-	-	1	V	
2	Standby off voltage	Vstd0ff	1	Vmute = 5V; Vin = 20mV; Gvc > 38 dB	4.5	-	-	V	
3	Mute on voltage	Vmon	1	VStdby = 5V; Vin = 20mV; MT > 70 dB	-	ı	1	V	
4	Mute off voltage	Vmoff	1	VStdby = 5V; Vin = 20mV; Gvc > 38 dB	4	-	-	V	

Note) The above characteristics are reference values determined for IC design, but not guaranteed values for shipping inspection. If problems were to occur, counter measures will be sincerely discussed.

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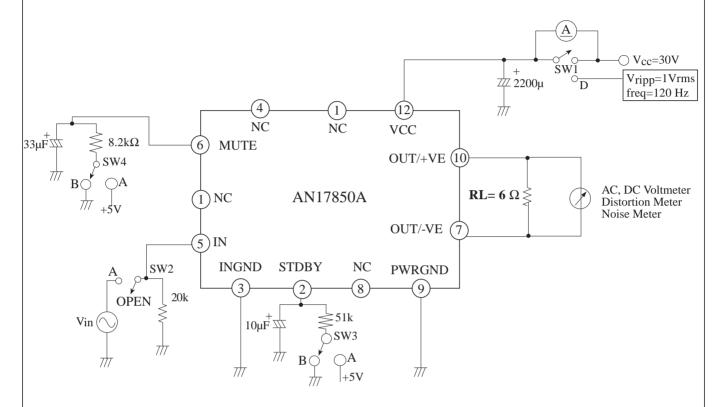
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(Description of Test Circuits and Test Methods)

Test Circuit 1



No.	Item	SW1	SW2	SW3	SW4
1	Icq	OPEN	OPEN	A	A
2	Vno	Closed	OPEN	A	A
3	Gvc	Closed	A	A	A
4	THD	Closed	A	A	A
5	PO	Closed	A	A	A
6	Voff	Closed	OPEN	A	A
7	R.R	D	OPEN	A	A
8	ISTB	OPEN	OPEN	В	A
9	MT	Closed	A	A	B/A

Note: * STB 'OFF' means 5V. MUTE 'OFF' means 5V.

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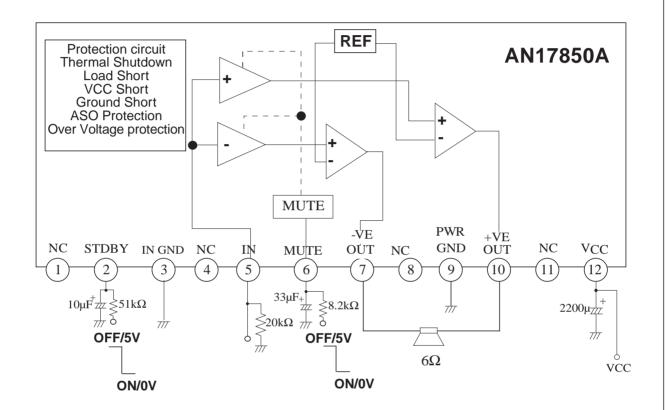
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Circuit Function Block Diagram



Pin Descriptions

Pin No.	Pin Descriptions	Pin No.	Pin Descriptions
1	NC	7	-VE PHASE OUTPUT
2	STDBY	8	NC
3	IN GND	9	PWR GND
4	NC	10	+VE PHASE OUTPUT
5	IN	11	NC
6	MUTE	12	VCC

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Total Page 17 Page No. 6	Prepared		Pro	duct Speci	fications	Ref No.	Е
Package Name FP-12S Unit:mm	Chaolad			Total Page	17		
Unit : mm 280 4 6.3 7.7 ± 0.3 7.8 ± 0.3 7.8 ± 0.3 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7 7.9 ± 0.7	Approved			T111/00			
3.6 ± 0.3 28.0 ± 0.3 28.0 ± 0.3 28.0 ± 0.3 3.5 ± 0.3 3.5 ± 0.3 3.5 ± 0.3						FP-12S	
28.0 ± 0.3 28.0 ± 0.3 28.0 ± 0.3 20.0±0.1 1.2 ± 0.1 1.2 ± 0.1 1.2 ± 0.1 1.3 ± 0.3 1.5 ± 0.3 1.5 ± 0.3					Unit: mm		
Date Code Company insignia		20.0±0.3 0.6	± 0.3 7.7		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		Name of item Date Code Company

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Product Specifications

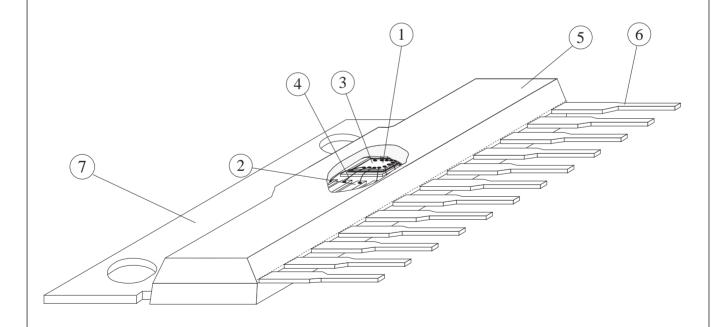
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(Structure Description)

Chip surface passivation	SiN,	PSG,	Others ()	1
Lead frame material	Fe group,	Cu group,	Others ()	2,6
Inner lead surface process	Ag plating,	Au plating,	Others ()	2
Outer lead surface process	Solder plating,	Solder dip,	Others ()	6
Chip mounting method	Ag paste,	Au-Si alloy, Solder,	Others ()	3
Wire bonding method	Thermalsonic bo	nding,	Others ()	4
Wire material	Au		Others ()	4
Mold material	Epoxy,		Others ()	5
Molding method	Transfer mold,	Multiplunger mold,	Others ()	(5)
Fin material	Cu Group		Others ()	7

Package FP-12S



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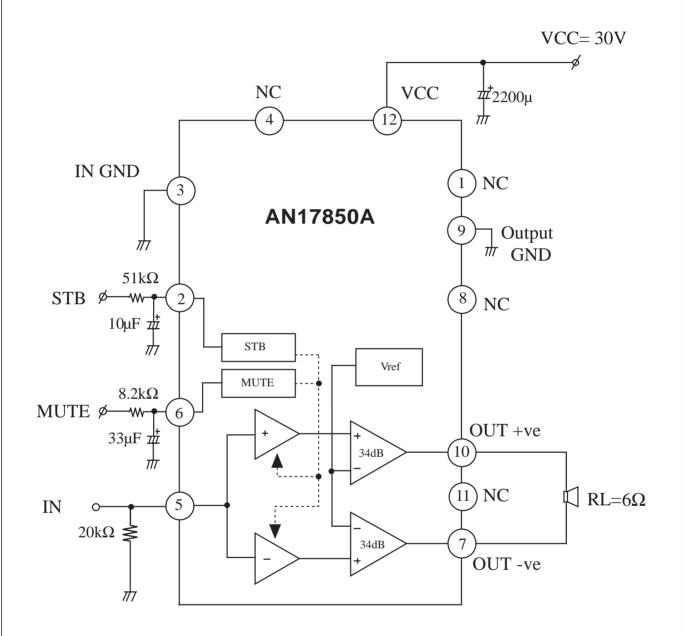
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Product Specifications (Technical Data)

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Application Circuit



STB 'OFF'	5V
STB 'ON'	0V
Mute 'OFF'	5V
Mute 'ON'	0V

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(Technical Data)

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(1) Tc = Ta, 62.5W (θ j-c = 2 °C/W)

(2) 20.83W ($\theta f = 4.0$ °C/W)

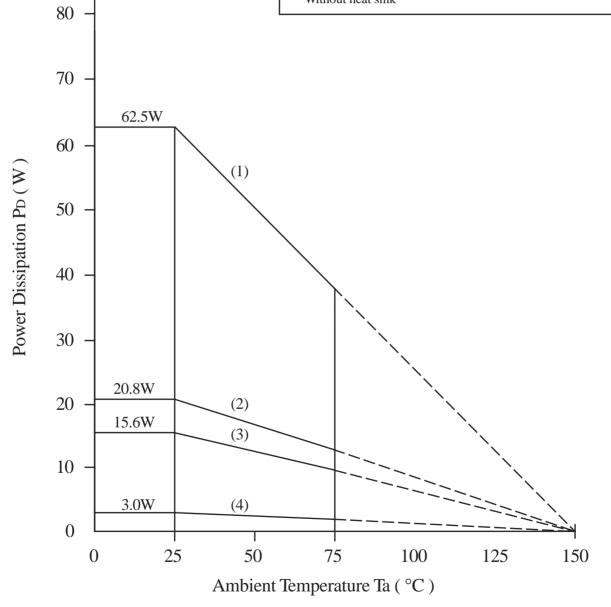
With a 100cm²X 3mm Al heat sink (black colour coated) or a 200cm² X 2mm Al heat sink (not lacquered)

(3) 15.63W ($\theta f = 6.0 \,^{\circ}\text{C/W}$)

With a 100cm² X 2mm Al heat sink (not lacquered)

(4) 3.0W at Ta = 25° C (θ j-a = 42° C/W)

Without heat sink



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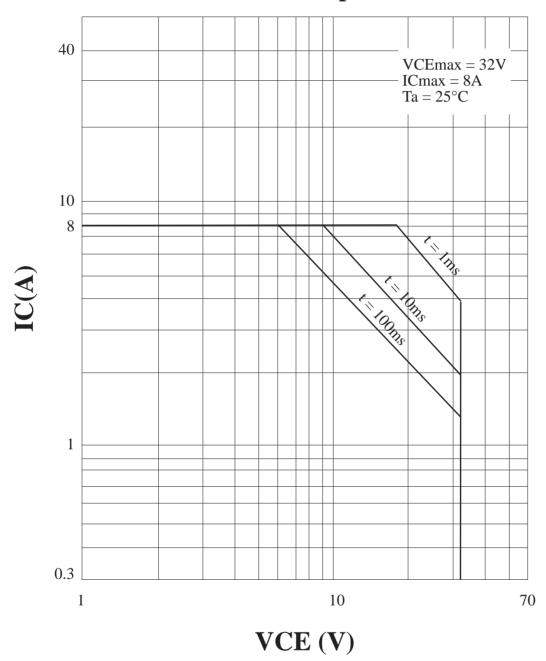
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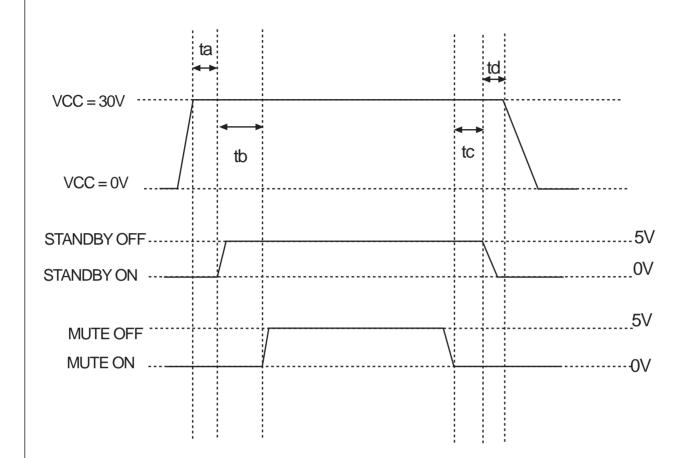
Area of Safe Operation



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	Description	Minimum	Unit
ta	Wating time required for Standby to turn off after VCC is on.	0	ms
tb	Wating time required for Mute turn off after Standby is off.	500	ms
tc	Wating time required for Standby to turn on after Mute is on	300	ms
td	Waiting time required for VCC to turn off after Standby is on	0	ms

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	Toved	111 (17 00 011	1 age 110.	12
Pin No.	Function	Internal circuitry	Description	DC BIAS (V)
1	NC			
2	Standby	100kΩ 100kΩ 100kΩ	Standby control pin Standby "ON" = 0V Standby "OFF" = 5V	Determined by external
3	IN GND		Input ground	0V
4	NC			
5	INPUT	200Ω 5 33kΩ 8.3kΩ	AC input Terminal	OV
6 MUTE		$\frac{12}{6}$ $\frac{400\Omega}{10.6k\Omega}$ $30k\Omega$ $\frac{2.65k\Omega}{10.6k\Omega}$	MUTE "OFF" = 5V MUTE ON = 0V	Determined by external
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Pin No.	Function	Internal circuitry	Description	DC BIAS (V)
7	Output (-)	Pre Amp Driver cct 7 7 $VCC/2$ 250Ω $15k\Omega$ 9 3	Negative output terminal	VCC/2
8	NC			
9	PWR GND		Output Power Ground	0V
10	Output (+)	Pre Amp Driver cct 10 $\sqrt{CC/2}$ $15k\Omega$ 9 $10k\Omega$	Positive output terminal	VCC/2
11	NC			
12	VCC		Power Supply Pin	Typ 30V

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Product Specifications (Technical Data)

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Power dissipation and Heat Sink

TA TC TJ HEAT SINK CASE DIE θ_{CA} θ_{JC}

FIG1. Simplified Illustration of IC and Heat Sink attached

Definition of terms

PD: Power Dissipation
Tj: Junction Temperature
TC: Case Temperature
TA: Ambient Temperature

θJC: Thermal Resistance of junction to case

θCA: Thermal Resistance of case to ambient, normally through heat sink

The following two equations represent the relations of these terms.

$$(Tj - TC) / \theta JC = PD$$
 (1)

$$(TC - TA) / \theta CA = PD'$$
 (2)

For reliable and long-term, continuous operation, junction temperature should not exceed 125°C and θ_{JC} for FP-12S package is 2°C/W. Substitute these values in Equation 1. After specify the PD, Tc can be determined.

Assume no heat loss at the casing,i.e. all power is dissipated to the ambient through heat sink, which is quite true. So PD = PD'. Since Tc is also known, one can determine the following using equation2:

a) The rating of heat sink for specific maximum operating ambient temperature, or b) The maximum operating ambient temperature for specific heat sink rating.

A more general equation can be used for rough calculation.

$$(TJ - TA) / \theta JA = PD$$
 (3)
 $\theta JA = \theta CA + \theta JC$ (4)

In this case, θ_{JA} is total thermal resistance of the heat sink and IC package. Therefore, for specified power dissipation, either heat sink rating or maximum operating ambient temperature can be decided if the other is known.

Take note that it's essential to know PD value before hand in order to work out other quantities. PD calculation is as shown.

$$PD = Vcc \times Icc - Po_total$$
 (5)

Vcc: DC supply voltage lcc: RMS value of IC current Po_total: Total output power

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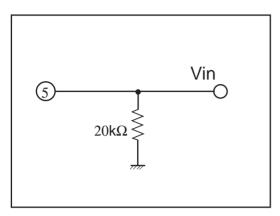


FIG2. Input DC Biasing

Input DC biasing

Input DC bias is maintained at ground level. If the input signal contains DC bias voltage, AC coupling should be included on the application circuit.

The value of $20k\Omega$ resistor is set in order to achieve the minimum output DC offset.

Output Zobel Network

It should be noted that this device is designed such that the Zobel network (RC pair) at the output pins is not necessary for stable operation.

In practical application, the Zobel network may be applied optionally for two reasons:

- a) Ensuring stability for different PCB layout and speaker types.
- b) Ability to withstand to high ESD levels.

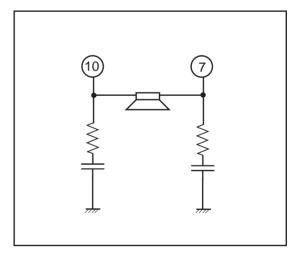


FIG3. Output Zobel Network

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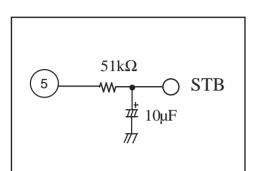


FIG4. Standby Application circuit

Standby operation

Standby pin should be connected with carefully selected components in order to avoid "Pop Noise" during Standby ON/OFF transient.

The 51k resistor and 10uF capacitor pair can delay the rising of voltage at pin 5 to reach the Standby threshold. When Standby is switching on together with supply, this delay would be very useful to ensure no "Pop Noise".

If the Standby voltage is provided by a microcontroller, the suppression of "Pop" could even be better.

For further details of timing and delay for standby circuit, please refer to page 11.

Mute operation

Mute pin should be connected with carefully selected components in order to avoid "Pop Noise" during MUTE ON/OFF transient.

The 8.2k resistor and 33uF capacitor pair can delay the rising of voltage at pin 6 to reach the Mute threshold. When Mute is switching on together with supply, this delay would be very useful to ensure no "Pop Noise".

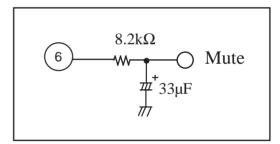


FIG5. Mute application circuit

For further details of timing and delay for Mute application circuit, please refer to page 11.

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(Precaution for use)

- 1) Ground the radiation fin so that there will be no difference in electric potential between the radiation fin and ground.
- 2) The thermal protection circuit operates at Tj at approximately 150°C. Thermal protection circuit is reset automatically when the temperature drops.
- 3) Be sure to attach heatsink to the IC before use. Make sure that the heatsink is secured to the chassis.
- 4) In order to prevent IC from being damaged during the fault test, prior to standby switching from on to off or vice versa, it is important to assert the mute on. Please refer to the timing diagram on page 11.

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